MMSD301T1G, SMMSD301T1G, MMSD701T1G, SMMSD701T1G,

SOD-123 Schottky Barrier Diodes

The MMSD301T1, and MMSD701T1 devices are spin-offs of our popular MMBD301LT1, and MMBD701LT1 SOT-23 devices. They are designed for high-efficiency UHF and VHF detector applications. Readily available to many other fast switching RF and digital applications.

Features

- Extremely Low Minority Carrier Lifetime
- Very Low Capacitance
- Low Reverse Leakage
- AEC Qualified and PPAP Capable
- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Reverse Voltage MMSD301T1G, SMMSD301T1G MMSD701T1G, SMMSD701T1G	V _R	30 70	Vdc
Forward Current (DC) Continous	IF	200	mA
Forward Power Dissipation T _A = 25°C	P _F	225	mW
Junction Temperature	TJ	-55 to +125	°C
Storage Temperature Range	T _{stg}	-55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



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SOD-123 CASE 425 STYLE 1



MARKING DIAGRAM



xx = Specific Device Code XT = MMSD301T1G SMMSD301T1G XH = MMSD701T1G SMMSD701T1G

M = Date Code= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
MMSD301T1G	SOD-123 (Pb-Free)	3,000 / Tape & Reel
SMMSD301T1G	SOD-123 (Pb-Free)	3,000 / Tape & Reel
MMSD701T1G	SOD-123 (Pb-Free)	3,000 / Tape & Reel
SMMSD701T1G	SOD-123 (Pb-Free)	3,000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

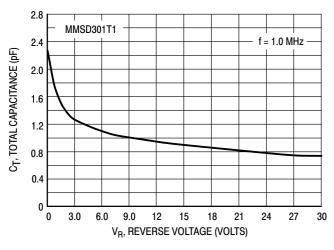
${\bf MMSD301T1G,\,SMMSD301T1G,\,MMSD701T1G,\,SMMSD701T1G,}$

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Breakdown Voltage (I _R = 10 μA) MMSD301T1G, SMMSD301T1G MMSD701T1G, SMMSD701T1G	V _{(BR)R}	30 70	- -	- -	V
Diode Capacitance (V _R = 0 V, f = 1.0 MHz) MMSD301T1G, SMMSD301T1G MMSD701T1G, SMMSD701T1G	C _T	- -	0.9 0.5	1.5 1.0	pF
Total Capacitance (V _R = 15 V, f = 1.0 MHz) MMSD301T1G, SMMSD301T1G (V _R = 20 V, f = 1.0 MHz) MMSD701T1G, SMMSD701T1G	C _T	-	0.9 0.5	1.5 1.0	pF
Reverse Leakage (V _R = 25 V) MMSD301T1G, SMMSD301T1G (V _R = 35 V) MMSD701T1G, SMMSD701T1G	I _R	-	13 9.0	200 200	nAdc
Forward Voltage $ \begin{aligned} &(I_F=1.0 \text{ mAdc})\\ &\text{MMSD301T1G, SMMSD301T1G}\\ &(I_F=10 \text{ mA})\\ &(I_F=1.0 \text{ mAdc})\\ &\text{MMSD701T1G, SMMSD701T1G}\\ &(I_F=10 \text{ mA}) \end{aligned} $	V _F	- - -	0.38 0.52 0.42 0.7	0.45 0.6 0.5 1.0	Vdc

MMSD301T1G, SMMSD301T1G, MMSD701T1G, SMMSD701T1G,

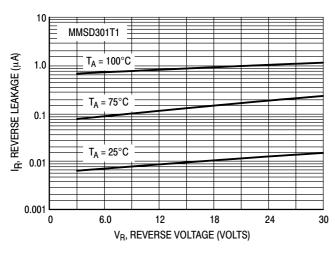
TYPICAL CHARACTERISTICS MMSD301T1G, SMMSD301T1G



500 MMSD301T1 τ , MINORITY CARRIER LIFETIME (ps) 400 KRAKAUER METHOD 300 200 100 20 70 100 0 10 50 90 I_F, FORWARD CURRENT (mA)

Figure 1. Total Capacitance

Figure 2. Minority Carrier Lifetime



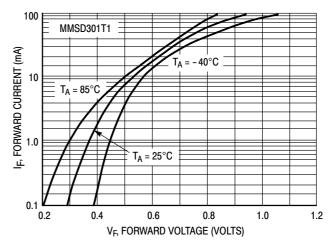
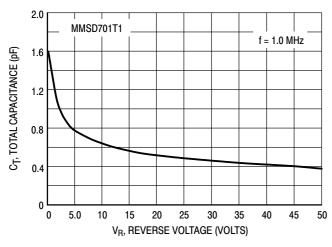


Figure 3. Reverse Leakage

Figure 4. Forward Voltage

MMSD301T1G, SMMSD301T1G, MMSD701T1G, SMMSD701T1G,

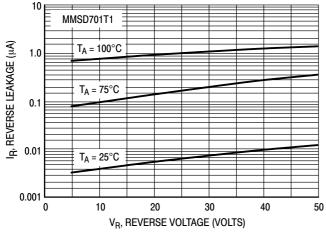
TYPICAL CHARACTERISTICS MMSD701T1G, SMMSD701T1G



500 MMSD701T1 τ , MINORITY CARRIER LIFETIME (ps) 400 KRAKAUER METHOD 300 200 100 0 10 20 30 40 50 60 70 80 90 100 I_F, FORWARD CURRENT (mA)

Figure 5. Total Capacitance

Figure 6. Minority Carrier Lifetime



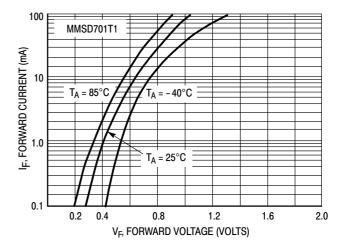


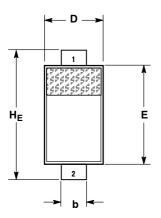
Figure 7. Reverse Leakage

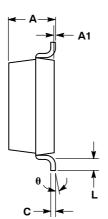
Figure 8. Forward Voltage

MMSD301T1G, SMMSD301T1G, MMSD701T1G, SMMSD701T1G,

PACKAGE DIMENSIONS

SOD-123 CASE 425-04 ISSUE G



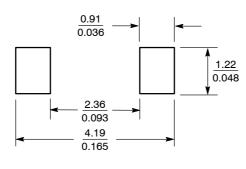


- 1. DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982
- 2. CONTROLLING DIMENSION: INCH.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.94	1.17	1.35	0.037	0.046	0.053
A1	0.00	0.05	0.10	0.000	0.002	0.004
b	0.51	0.61	0.71	0.020	0.024	0.028
С			0.15		-	0.006
D	1.40	1.60	1.80	0.055	0.063	0.071
E	2.54	2.69	2.84	0.100	0.106	0.112
HE	3.56	3.68	3.86	0.140	0.145	0.152
L	0.25			0.010	-	
θ	0°		10°	0°		10°

STYLE 1: PIN 1. CATHODE 2 ANODE

SOLDERING FOOTPRINT*



mm SCALE 10:1

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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